

Titles of Most Frequently Occurring Classifications of Patents Returned
From A Search of 09995362 on June 05, 2003

33 165/80.3 (16 OR, 17 XR)

Class 165 : HEAT EXCHANGE

165/80.1 WITH RETAINER FOR REMOVABLE ARTICLE

165/80.2 .Electrical component

165/80.3 ..Air cooled, including fins

25 361/695 (12 OR, 13 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/689 ...Fluid

361/690Air

361/694With air circulating means

361/695Fan or blower

23 361/697 (4 OR, 19 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/689 ...Fluid

361/690Air

361/694With air circulating means

361/695Fan or blower

361/697With heat sink or cooling fins

19 257/E23.099 (0 OR, 19 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

257/E23.03Carbon (EPO)

257/E23.08 .Arrangements for cooling, heating, ventilating
or temperature compensation; temperature-sensing
arrangements (EPO)

257/E23.097 ..Involving transfer of heat by flowing fluids
(EPO)

257/E23.099 ...By flowing gases, e.g., air (EPO)

18 165/185 (0 OR, 18 XR)

Class 165 : HEAT EXCHANGE

165/185 HEAT TRANSMITTER

16 174/16.3 (0 OR, 16 XR)

Class 174 : ELECTRICITY: CONDUCTORS AND INSULATORS

174/8 WITH FLUIDS OR VACUUM

174/15.1 .With cooling or fluid feeding, circulating or
distributing

174/16.1 ..By ventilation or gas circulation

174/16.3 ...With heat sink

15 361/687 (5 OR, 10 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/683 ..Computer related support

361/687 ...With cooling means

14 165/104.33 (2 OR, 12 XR)

Class 165 : HEAT EXCHANGE

165/104.11 INTERMEDIATE FLUENT HEAT EXCHANGE MATERIAL
RECEIVING AND DISCHARGING HEAT

165/104.19 .Liquid fluent heat exchange material

165/104.33 ..Cooling electrical device

11 361/704 (1 OR, 10 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/704 ...Thermal conduction

10 361/690 (1 OR, 9 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/689 ...Fluid

361/690Air

8 257/E23.088 (0 OR, 8 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

257/E23.03Carbon (EPO)

257/E23.08 ..Arrangements for cooling, heating, ventilating
or temperature compensation; temperature-sensing
arrangements (EPO)

257/E23.087 ..Fillings or auxiliary members in containers
or encapsulations selected or arranged to facilitate
heating or cooling (EPO)

257/E23.088 ...Cooling by change of state, e.g., use of
heat pipes (EPO)

8 361/700 (2 OR, 6 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 ..For electronic systems and devices

361/688 ..With cooling means

361/689 ...Fluid

361/699Liquid

361/700Change of physical state

8 454/184 (2 OR, 6 XR)

Class 454 : VENTILATION

454/184 ELECTRONIC CABINET

6 165/121 (0 OR, 6 XR)

Class 165 : HEAT EXCHANGE

165/120 WITH IMPELLER OR CONVEYOR MOVING EXCHANGE
MATERIAL

165/121 ..Mechanical gas pump

6 257/715 (0 OR, 6 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

257/688 ..With large area flexible electrodes in press
contact with opposite sides of active semiconductor chip
and surrounded by an insulating element, e.g., ring

257/712 ..With provision for cooling the housing or its
contents

257/714 ..Liquid coolant

257/715 ...Boiling (evaporative) liquid

6 257/722 (0 OR, 6 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

- 257/688 .With large area flexible electrodes in press
contact with opposite sides of active semiconductor chip
and surrounded by an insulating element, e.g., ring
- 257/712 .With provision for cooling the housing or its
contents
- 257/721 ..With gas coolant
- 257/722 ...With fins

5 62/259.2 (4 OR, 1 XR)

Class 062 : REFRIGERATION

- 62/259.1 STRUCTURAL INSTALLATION
- 62/259.2 .With electrical component cooling

5 174/16.1 (0 OR, 5 XR)

Class 174 : ELECTRICITY: CONDUCTORS AND INSULATORS

- 174/8 WITH FLUIDS OR VACUUM
- 174/15.1 .With cooling or fluid feeding, circulating or
distributing
- 174/16.1 ..By ventilation or gas circulation

5 257/719 (0 OR, 5 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

- 257/688 .With large area flexible electrodes in press
contact with opposite sides of active semiconductor chip
and surrounded by an insulating element, e.g., ring
- 257/712 .With provision for cooling the housing or its
contents
- 257/718 ..Heat dissipating element held in place by
clamping or spring means
- 257/719 ...Pressed against semiconductor element

5 361/694 (1 OR, 4 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

- 361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS
- 361/679 .For electronic systems and devices
- 361/688 ..With cooling means
- 361/689 ...Fluid
- 361/690Air
- 361/694With air circulating means

5 361/707 (0 OR, 5 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/704 ...Thermal conduction

361/707Through support means

4 174/15.2 (0 OR, 4 XR)

Class 174 : ELECTRICITY: CONDUCTORS AND INSULATORS

174/8 WITH FLUIDS OR VACUUM

174/15.1 .With cooling or fluid feeding, circulating or
distributing

174/15.2 ..By heat pipe

4 257/707 (0 OR, 4 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

257/688 .With large area flexible electrodes in press
contact with opposite sides of active semiconductor chip
and surrounded by an insulating element, e.g., ring

257/701 .Insulating material

257/706 ..With heat sink

257/707 ...Directly attached to semiconductor device

4 257/713 (0 OR, 4 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

257/688 .With large area flexible electrodes in press
contact with opposite sides of active semiconductor chip
and surrounded by an insulating element, e.g., ring

257/712 .With provision for cooling the housing or its
contents

257/713 ..For integrated circuit

4 257/718 (1 OR, 3 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

257/688 .With large area flexible electrodes in press
contact with opposite sides of active semiconductor chip
and surrounded by an insulating element, e.g., ring

257/712 .With provision for cooling the housing or its
contents

257/718 ..Heat dissipating element held in place by
clamping or spring means

4 257/E23.086 (0 OR, 4 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

257/E23.03Carbon (EPO)

257/E23.08 ..Arrangements for cooling, heating, ventilating
or temperature compensation; temperature-sensing
arrangements (EPO)

257/E23.083 ..Mountings or securing means for detachable
cooling or heating arrangements; fixed by friction, plugs
or springs (EPO)

257/E23.086 ...Snap-on arrangements, e.g., clips (EPO)

4 361/696 (0 OR, 4 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/689 ...Fluid

361/690Air

361/694With air circulating means

361/695Fan or blower

361/696With heat exchanger unit

4 361/703 (1 OR, 3 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/689 ...Fluid

361/703With cooling fins

3 165/122 (0 OR, 3 XR)

Class 165 : HEAT EXCHANGE

165/120 WITH IMPELLER OR CONVEYOR MOVING EXCHANGE
MATERIAL

165/121 .Mechanical gas pump

165/122 ..Heating or cooling means and gas pump in
housing

3 165/123 (1 OR, 2 XR)

Class 165 : HEAT EXCHANGE

165/120 WITH IMPELLER OR CONVEYOR MOVING EXCHANGE
MATERIAL

- 165/121 .Mechanical gas pump
- 165/122 ..Heating or cooling means and gas pump in
 housing
- 165/123 ...With injector-type gas pump

- 3 165/80.2 (0 OR, 3 XR)
 Class 165 : HEAT EXCHANGE
 165/80.1 WITH RETAINER FOR REMOVABLE ARTICLE
 165/80.2 .Electrical component

- 3 165/908 (0 OR, 3 XR)
 Class 165 : HEAT EXCHANGE
 165/908 FLUID JETS

- 3 257/714 (1 OR, 2 XR)
 Class 257 : ACTIVE SOLID-STATE DEVICES
 257/688 ..With large area flexible electrodes in press
 contact with opposite sides of active semiconductor chip
 and surrounded by an insulating element, e.g., ring
 257/712 ..With provision for cooling the housing or its
 contents
 257/714 ..Liquid coolant

- 3 257/721 (0 OR, 3 XR)
 Class 257 : ACTIVE SOLID-STATE DEVICES
 257/688 ..With large area flexible electrodes in press
 contact with opposite sides of active semiconductor chip
 and surrounded by an insulating element, e.g., ring
 257/712 ..With provision for cooling the housing or its
 contents
 257/721 ..With gas coolant

- 3 257/E23.105 (0 OR, 3 XR)
 Class 257 : ACTIVE SOLID-STATE DEVICES
 257/E23.03 Carbon (EPO)
 257/E23.08 ..Arrangements for cooling, heating, ventilating
 or temperature compensation; temperature-sensing
 arrangements (EPO)
 257/E23.101 ..Selection of materials, or shaping, to
 facilitate cooling or heating, e.g., heat sinks (EPO)
 257/E23.102 ...Cooling facilitated by shape of device (EPO)

 257/E23.105 Wire-like or pin-like cooling fins or heat
 sinks (EPO)

3 312/236 (2 OR, 1 XR)

Class 312 : SUPPORTS: CABINET STRUCTURE
312/236 WITH HEATING, COOLING OR HEAT EXCHANGE MEANS

3 361/685 (0 OR, 3 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/683 ..Computer related support

361/684 ...Memory unit support

361/685Disk drive support

3 361/689 (1 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/689 ...Fluid

3 361/719 (0 OR, 3 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/704 ...Thermal conduction

361/717For active solid state devices

361/718For integrated circuit

361/719Circuit board mounted

3 361/796 (0 OR, 3 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/748 ..Printed circuit board

361/784 ...Plural

361/796With housing or chassis

2 34/417 (0 OR, 2 XR)

Class 034 : DRYING AND GAS OR VAPOR CONTACT WITH SOLIDS

34/282 PROCESS

34/417 .With sealing of treating chamber

2 62/179 (1 OR, 1 XR)

Class 062 : REFRIGERATION

62/132 AUTOMATIC CONTROL

62/177 .Of external fluid or means

62/178 ..Diverse control or response

62/179 ...Plural external fluids or means controlled

2 165/104.34 (0 OR, 2 XR)

Class 165 : HEAT EXCHANGE

165/104.11 INTERMEDIATE FLUENT HEAT EXCHANGE MATERIAL
RECEIVING AND DISCHARGING HEAT

165/104.34 .Including means to move gaseous heat exchange
material

2 165/109.1 (0 OR, 2 XR)

Class 165 : HEAT EXCHANGE

165/109.1 WITH AGITATING OR STIRRING STRUCTURE

2 165/125 (0 OR, 2 XR)

Class 165 : HEAT EXCHANGE

165/120 WITH IMPELLER OR CONVEYOR MOVING EXCHANGE
MATERIAL

165/121 .Mechanical gas pump

165/122 ..Heating or cooling means and gas pump in
housing

165/124 ...Verging gas flow

165/125Radial flow through annular heating or
cooling means

2 165/80.4 (1 OR, 1 XR)

Class 165 : HEAT EXCHANGE

165/80.1 WITH RETAINER FOR REMOVABLE ARTICLE

165/80.2 .Electrical component

165/80.4 ..Liquid cooled

2 165/903 (0 OR, 2 XR)

Class 165 : HEAT EXCHANGE

165/903 CONVECTION

2 165/96 (2 OR, 0 XR)

Class 165 : HEAT EXCHANGE

165/96 WITH ADJUSTOR FOR HEAT, OR EXCHANGE MATERIAL,
FLOW

2 219/400 (1 OR, 1 XR)

Class 219 : ELECTRIC HEATING

219/260 .Resistive element: igniter type

219/385 .Combined with container, enclosure, or support
for material to be heated

219/391 ..Oven type

219/399 ...With heat energy transfer, distribution, or
accumulator means

219/400By convection

2 257/712 (0 OR, 2 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

257/688 .With large area flexible electrodes in press
contact with opposite sides of active semiconductor chip
and surrounded by an insulating element, e.g., ring

257/712 .With provision for cooling the housing or its
contents

2 257/727 (0 OR, 2 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

257/688 .With large area flexible electrodes in press
contact with opposite sides of active semiconductor chip
and surrounded by an insulating element, e.g., ring

257/727 .Device held in place by clamping

2 257/E23.103 (0 OR, 2 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

257/E23.03Carbon (EPO)

257/E23.08 .Arrangements for cooling, heating, ventilating
or temperature compensation; temperature-sensing
arrangements (EPO)

257/E23.101 ..Selection of materials, or shaping, to
facilitate cooling or heating, e.g., heat sinks (EPO)

257/E23.102 ...Cooling facilitated by shape of device (EPO)

257/E23.103Foil-like cooling fins or heat sinks (EPO)

2 257/E23.112 (0 OR, 2 XR)

Class 257 : ACTIVE SOLID-STATE DEVICES

- 257/E23.03Carbon (EPO)
- 257/E23.08 ..Arrangements for cooling, heating, ventilating or temperature compensation; temperature-sensing arrangements (EPO)
- 257/E23.101 ..Selection of materials, or shaping, to facilitate cooling or heating, e.g., heat sinks (EPO)
- 257/E23.11 ...Cooling facilitated by selection of materials for device (or materials for thermal expansion adaptation, e.g., carbon) (EPO)
- 257/E23.112Having heterogeneous or anisotropic structure, e.g., powder or fibers in matrix, wire mesh, porous structures (EPO)

2 261/106 (0 OR, 2 XR)

Class 261 : GAS AND LIQUID CONTACT APPARATUS

261/75 CONTACT DEVICES

261/100 .Porous sheet

261/106 ..Liquid downflow

2 261/30 (0 OR, 2 XR)

Class 261 : GAS AND LIQUID CONTACT APPARATUS

261/19 FLUID DISTRIBUTION

261/24 .Pumping

261/30 ..Gas inlet

2 307/141 (2 OR, 0 XR)

Class 307 : ELECTRICAL TRANSMISSION OR INTERCONNECTION SYSTEMS

307/112 SWITCHING SYSTEMS

307/139 .Switch actuation

307/141 ..With time delay or retardation means

2 310/68C (0 OR, 2 XR)

Class 310 : ELECTRICAL GENERATOR OR MOTOR STRUCTURE

310/10 DYNAMOELECTRIC

310/40R .Rotary

310/66 ..With other elements

310/68R ...Electric circuit elements

310/68CTemperature, current-responsive, i.e., protectors

2 312/31 (0 OR, 2 XR)

Class 312 : SUPPORTS: CABINET STRUCTURE

312/31 WITH GAS OR VAPOR TREATMENT OF MATERIAL

2 361/23 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/1 SAFETY AND PROTECTION OF SYSTEMS AND DEVICES
361/23 ..Motor protective condition responsive circuits

2 361/683 (1 OR, 1 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS
361/679 ..For electronic systems and devices
361/683 ..Computer related support

2 361/691 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS
361/679 ..For electronic systems and devices
361/688 ..With cooling means
361/689 ...Fluid
361/690Air
361/691Pressurized or conditioned

2 361/692 (1 OR, 1 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS
361/679 ..For electronic systems and devices
361/688 ..With cooling means
361/689 ...Fluid
361/690Air
361/692Plural Openings

2 361/699 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS
361/679 ..For electronic systems and devices
361/688 ..With cooling means
361/689 ...Fluid

361/699Liquid

2 361/701 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/689 ...Fluid

361/701With heat exchanger unit

2 361/702 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/689 ...Fluid

361/702With cold plate or heat sink

2 361/709 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/704 ...Thermal conduction

361/707Through support means

361/709Heat sink

2 361/710 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/704 ...Thermal conduction

361/707Through support means

361/709Heat sink

361/710Details

2 361/714 (1 OR, 1 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/704 ...Thermal conduction

361/714Through component housing

2 361/717 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/704 ...Thermal conduction

361/717For active solid state devices

2 361/718 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/704 ...Thermal conduction

361/717For active solid state devices

361/718For integrated circuit

2 361/720 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS

361/679 .For electronic systems and devices

361/688 ..With cooling means

361/704 ...Thermal conduction

361/720For printed circuit board

2 361/721 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE

ELECTRICAL COMPONENTS

- 361/679 .For electronic systems and devices
- 361/688 ..With cooling means
- 361/704 ...Thermal conduction
- 361/720For printed circuit board
- 361/721Plural

2 361/724 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

- 361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS
- 361/679 .For electronic systems and devices
- 361/724 ..Cabinet-type housing

2 361/790 (0 OR, 2 XR)

Class 361 : ELECTRICITY: ELECTRICAL SYSTEMS AND DEVICES

- 361/600 HOUSING OR MOUNTING ASSEMBLIES WITH DIVERSE
ELECTRICAL COMPONENTS
- 361/679 .For electronic systems and devices
- 361/748 ..Printed circuit board
- 361/784 ...Plural
- 361/785With separable connector or socket means
- 361/790Stacked

2 363/144 (2 OR, 0 XR)

Class 363 : ELECTRIC POWER CONVERSION SYSTEMS

- 363/25With automatic control of the magnitude of
output voltage or current
- 363/144 .With conductive support mounting

2 902/30 (0 OR, 2 XR)

Class 902 : ELECTRONIC FUNDS TRANSFER

- 902/30 SUPPORT OR ENCLOSURE (E.G., KIOSK)